

110-13-316-41-001000

110-13-316-41-001000 Information

	 110-13-316-41-001000 Mill-Max Manufacturing Corp. Connectors, Interconnects Sockets for ICs, Transistors CONN IC DIP SOCKET 16POS GOLD - For the pricing/inventory/lead time, please contact us	
For Reference Only	Website: https://www.heisener.com E-mail: salesdept@heisener.com	Request a Quote

Certified Quality

Heisener's commitment to quality has shaped our processes for sourcing, testing, shipping, and every step in between. This foundation underlies each component we sell.



110-13-316-41-001000 Specifications

Manufacturer Part Number110-13-316-41-00100ManufacturerMill-Max Manufacturing Corp.CategoryConnectors, InterconnectsBackage-Series110TypeDIP, 0.3" (7.62mm) Row SpacingNumber of Positions or Pins (Grid)16 (2 x 8)Pitch - MatingGoldContact Finish - MatingGoldContact Finish Thickness - MatingBeryllium CopperMounting TypeThrough HoleFeaturesOpen FramePitch - PostGoldForminationSolderForting FostGoldContact Finish - MatingGoldContact Finish Thickness - MatingGoleFeaturesOpen FrameForting TypeGoldForting TypeGoldContact Finish - MatingGoldForting TypeGoldFeaturesGoldForting TypeGoldForting TypeGold<			
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TerminationSolderPitch - Post0.100" (2.54mm)Contact Finish - PostGoldContact Finish Thickness - Post10µin (0.25µm)Contact Material - PostBrass Alloy	Mounting Type	Through Hole	
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Contact Finish Thickness - Post10μin (0.25μm)Contact Material - PostBrass Alloy	Pitch - Post	0.100" (2.54mm)	
Contact Material - Post Brass Alloy	Contact Finish - Post	Gold	
	Contact Finish Thickness - Post	10µin (0.25µm)	
Housing Material Polycyclohexylenedimethylene Terephthalate (PCT), Polyester	Contact Material - Post	Brass Alloy	
	Housing Material	Polycyclohexylenedimethylene Terephthalate (PCT), Polyester	
Operating Temperature $-55^{\circ}C \sim 125^{\circ}C$	Operating Temperature	-55°C ~ 125°C	
Report errors			Report errors?

110-13-316-41-001000 Guarantees



Quality Guarantees

We provide 90 days warranty. * If the items you received were not in perfect quality, we would be responsible for your refund or replacement, but the items must be returned in their original condition.

SERVICE BUARANTEE

Service Guarantees

We guarantee 100% customer satisfaction. Our experienced sales team and tech support team back our services to satisfy all our customers.

110-13-316-41-001000 Payment Methods





If you have any question about 110-13-316-41-001000, please do not hesitate to contact us! Website: https://www.heisener.com E-mail: salesdept@heisener.com